

RECEIVED  
CENTRAL FAX CENTER

NOV 30 2005

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. No.: 10/665,669

Applicant(s): Alcoe et al.

Filed.: September 18, 2003

Art Unit: 2814

Dkt. No.: END920010135US2

Examiner: Le, Thao X.

Title: **ENHANCED LID FOR MULTI-CHIP MODULES**

---

Honorable Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Applicants request the attached amendment be entered.